

10V Drive Nch MOSFET

RCJ330N25

● Structure

Silicon N-channel MOSFET

● Features

- 1) Low on-resistance.
- 2) Fast switching speed.
- 3) Gate-source voltage
 V_{GSS} guaranteed to be $\pm 30V$.
- 4) High package power.

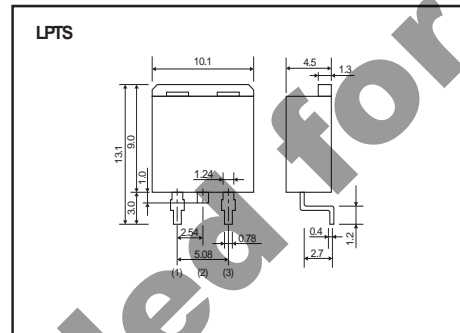
● Application

Switching

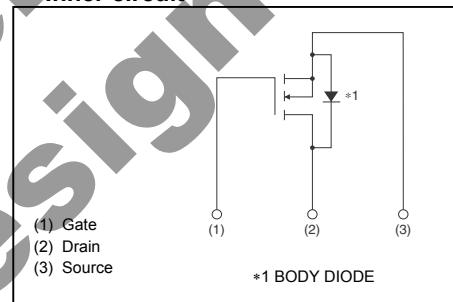
● Packaging specifications

Type	Package	Taping
	Code	TL
	Basic ordering unit (pieces)	1000
RCJ330N25		○

● Dimensions (Unit : mm)



● Inner circuit



● Absolute maximum ratings (Ta = 25°C)

Parameter	Symbol	Limits	Unit	
Drain-source voltage	V_{DSS}	250	V	
Gate-source voltage	V_{GSS}	± 30	V	
Drain current	Continuous	I_D *3	± 33	A
	Pulsed	I_{DP} *1	± 132	A
Source current (Body Diode)	Continuous	I_S *3	26	A
	Pulsed	I_{SP} *1	104	A
Avalanche current	I_{AS} *2	16.5	A	
Avalanche energy	E_{AS} *2	74.8	mJ	
Power dissipation (Tc=25°C)	P_D	211	W	
Channel temperature	Tch	150	°C	
Range of storage temperature	Tstg	-55 to +150	°C	

*1 $P_w \leq 10\mu s$, Duty cycle $\leq 1\%$

*2 $L = 500\mu H$, $V_{DD} = 50V$, $R_g = 25\Omega$, starting Tch=25°C

*3 Limited only by maximum temperature allowed.

● Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to Case	$R_{th(j-c)}$ *	0.59	°C / W

* $T_c = 25^\circ C$

● Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I_{GSS}	-	-	± 100	nA	$V_{GS}=\pm 30V, V_{DS}=0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	250	-	-	V	$I_D=1mA, V_{GS}=0V$
Zero gate voltage drain current	I_{DSS}	-	-	1	μA	$V_{DS}=250V, V_{GS}=0V$
Gate threshold voltage	$V_{GS(th)}$	3	-	5	V	$V_{DS}=10V, I_D=1mA$
Static drain-source on-state resistance	$R_{DS(on)^*}$	-	77	105	m Ω	$I_D=16.5A, V_{GS}=10V$
Forward transfer admittance	$ Y_{fs} ^*$	10	20	-	S	$I_D=16.5A, V_{DS}=10V$
Input capacitance	C_{iss}	-	4500	-	pF	$V_{DS}=25V$
Output capacitance	C_{oss}	-	220	-	pF	$V_{GS}=0V$
Reverse transfer capacitance	C_{rss}	-	130	-	pF	$f=1MHz$
Turn-on delay time	$t_{d(on)}^*$	-	50	-	ns	$I_D=16.5A, V_{DD} \approx 125V$
Rise time	t_r^*	-	200	-	ns	$V_{GS}=10V$
Turn-off delay time	$t_{d(off)}^*$	-	120	-	ns	$R_L=7.6\Omega$
Fall time	t_f^*	-	140	-	ns	$R_G=10\Omega$
Total gate charge	Q_g^*	-	80	-	nC	$I_D=33A,$
Gate-source charge	Q_{gs}^*	-	25	-	nC	$V_{DD} \approx 125V$
Gate-drain charge	Q_{gd}^*	-	27	-	nC	$V_{GS}=10V$

*Pulsed

● Body diode characteristics (Source-Drain) (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward Voltage	V_{SD}^*	-	-	1.5	V	$I_S=33A, V_{GS}=0V$

*Pulsed

●Electrical characteristic curves (Ta=25°C)

Fig.1 Typical Output Characteristics (I)

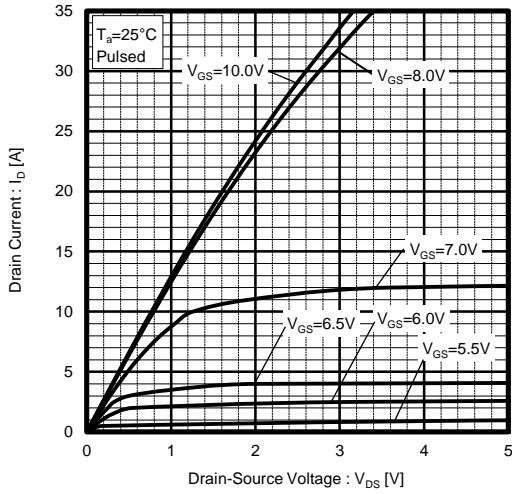


Fig.2 Typical Output Characteristics (II)

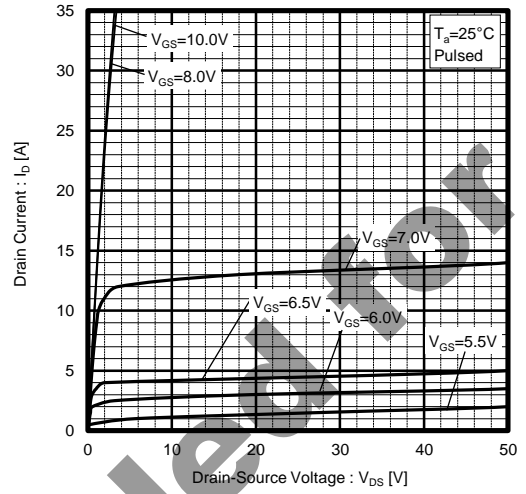


Fig.3 Typical Transfer Characteristics

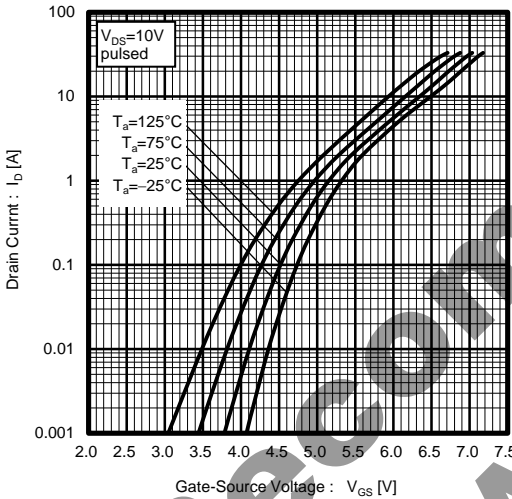


Fig.4 Gate Threshold Voltage vs. Channel Temperature

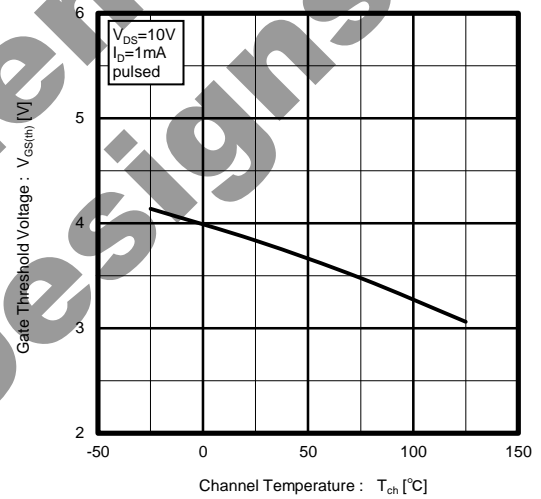


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

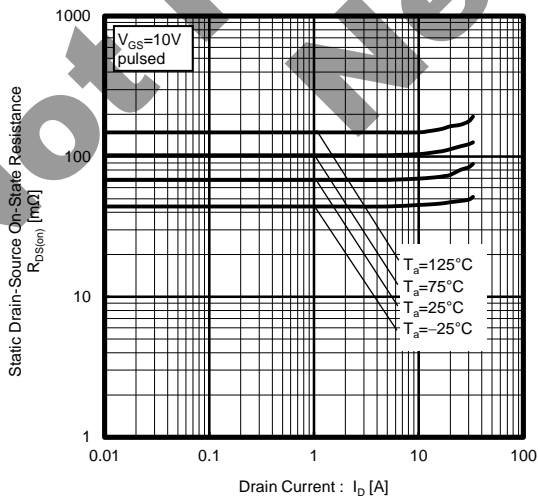


Fig.6 Static Drain-Source On-State Resistance vs. Channel Temperature

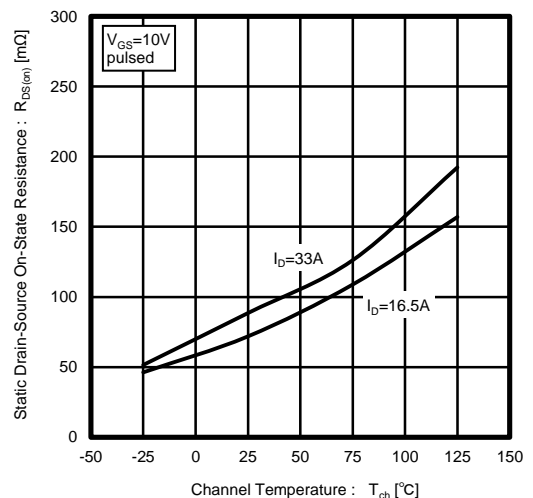


Fig.7 Forward Transfer Admittance vs. Drain Current

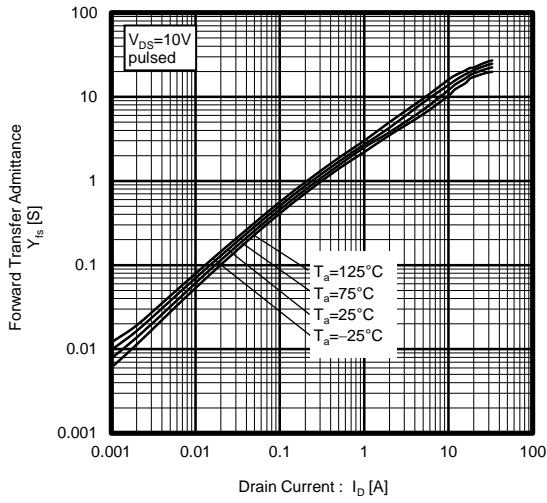


Fig.8 Source Current vs. Source-Drain Voltage

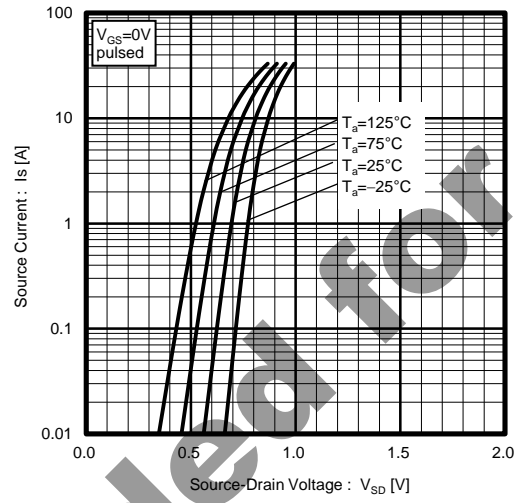


Fig.9 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

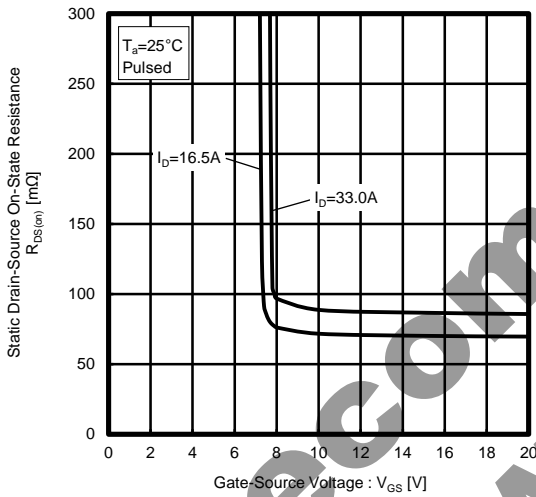


Fig.10 Switching Characteristics

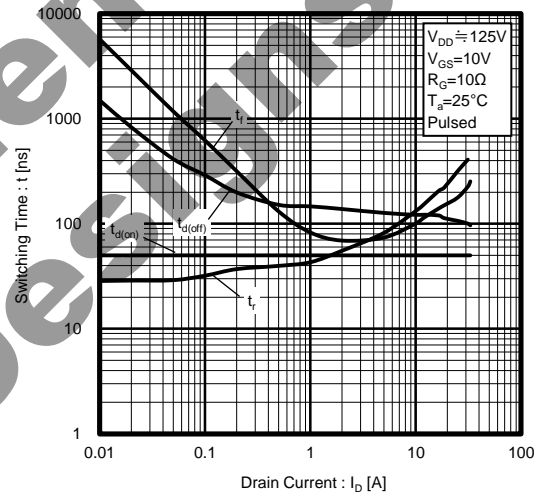


Fig.11 Dynamic Input Characteristics

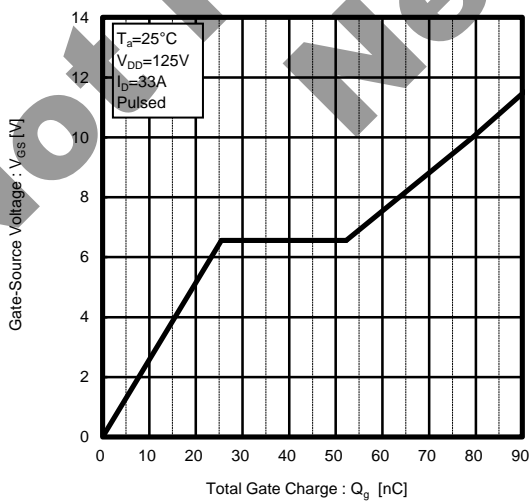


Fig.12 Typical Capacitance vs. Drain-Source Voltage

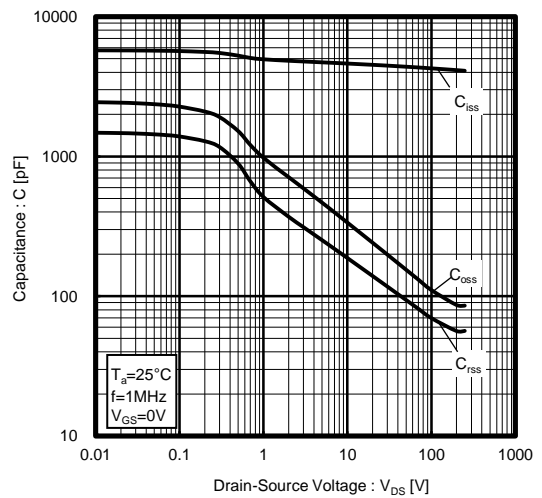


Fig.13 Maximum Safe Operating Area

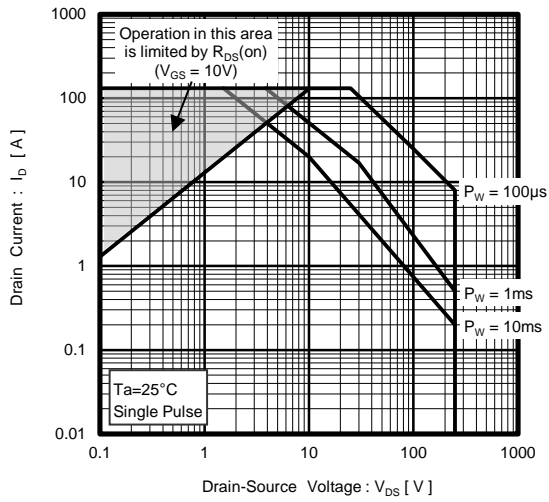
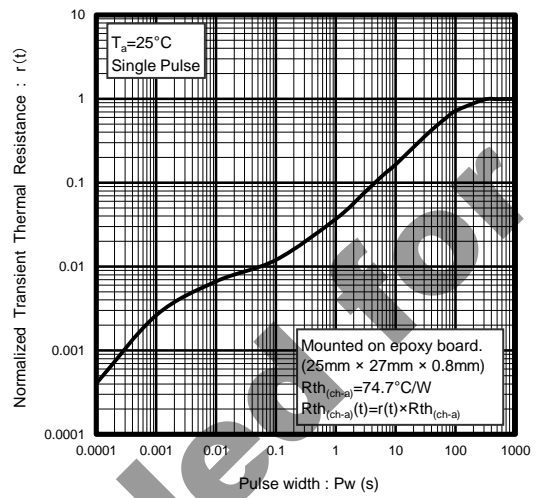


Fig.14 Normalized Transient Thermal Resistance v.s. Pulse Width



Not Recommended for New Designs

● Measurement circuits

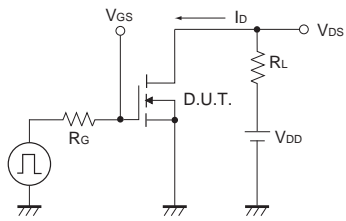


Fig.1-1 Switching Time Measurement Circuit

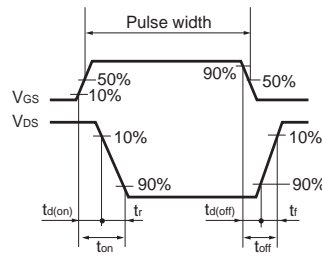


Fig.1-2 Switching Waveforms

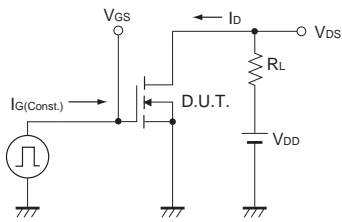


Fig.2-1 Gate Charge Measurement Circuit

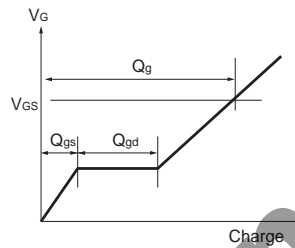


Fig.2-2 Gate Charge Waveform

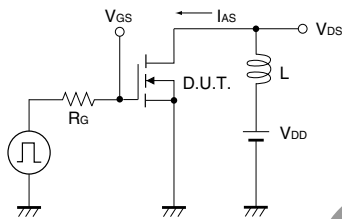


Fig.3-1 Avalanche Measurement Circuit

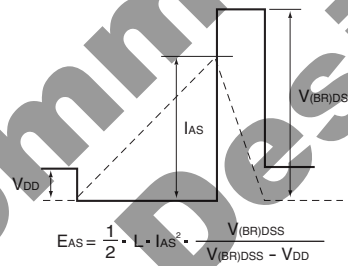


Fig.3-2 Avalanche Waveform

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 - Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
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 - Use of the Products in places subject to dew condensation
- The Products are not subject to radiation-proof design.
- Please verify and confirm characteristics of the final or mounted products in using the Products.
- In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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- In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

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 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
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